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(21) International Application Number: PCT/IB99/01869 (22) International Filing Date: 22 November 1999 (22.11.99) (30) Priority Data: 09/203,194 30 November 1998 (30.11.98) US (71) Applicant: OUTOKUMPU OYJ [FI/FI]; Riihitontuntie 7, FIN-Espoo (FI). (72) Inventors: KAMF, Anders; 57 Kinderhook court, Amherst, NY 14501 (US). WOJNICZ, Lawrance; 3307 14th Street, Kendsha, WI 53144 (US). (74) Agent: TIITINEN, Heikki; Outokumpu Oyj, Patent Services, P.O. Box 27, FIN-02201 Espoo (FI).		(81) Designated States: BR, CA, CN, CZ, HU, ID, IN, JP, KR, MX, PL, SG, SK, European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE). Published <i>With international search report.</i>
(54) Title: PROCESSES FOR PRODUCING ARTICLES WITH STRESS-FREE SLIT EDGES		
(57) Abstract		
Processes for producing articles with stress-free edges which comprise slitting a copper or copper alloy sheet to provide strips of the copper material, heating the strips in a furnace at a temperature of 200-250 °C under a protective atmosphere, and cooling the strips to room temperature, the strips so produced being useful to make stamped articles.		